

BRIEF REPORTS AND COMMENTS

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Embedding a carbon nanotube across the diameter of a solid state nanopore

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A fabrication method for positioning and embedding a single-walled carbon nanotube (SWNT) across the diameter of a solid state nanopore is presented. Chemical vapor deposition (CVD) is used to grow SWNTs over arrays of focused ion beam (FIB) milled pores in a thin silicon nitride membrane. This typically yields at least one pore whose diameter is centrally crossed by a SWNT. The final diameter of the FIB pore is adjusted to create a nanopore of any desired diameter by atomic layer deposition, simultaneously embedding and insulating the SWNT everywhere but in the region that crosses the diameter of the final nanopore, where it remains pristine and bare. This nanotube-articulated nanopore is an important step towards the realization of a new type of detector for biomolecule sensing and electronic characterization, including DNA sequencing. © 2011 American Vacuum Society. [DOI: 10.1116/1.3628602]

I. INTRODUCTION AND RATIONALE

A nanopore through a solid state membrane or a biological cell membrane separating two ionic-solution filled compartments has shown itself to be a promising and versatile type of single molecule detector, capable of sensing the properties of both single small molecules and long polymers in solution.^{1–7} When a bias of 60 – 500 mV is applied across the membrane separating the two ionic solutions, charged polymeric molecules (e.g., DNA) in the solution are electrophoretically driven through the nanopore and each molecule can be detected as it traverses through the nanopore constriction.

Until now, molecular detection has usually relied on observing a drop in the ionic conductivity as each molecule is driven through a single nanopore. The resolution and sensitivity of this molecule detector have been limited by the very small changes in ionic current and the high speed at which a DNA polymer translocates through the nanopore (usually >1 nucleotide/ μsec for solid state nanopores).^{8,9} One is therefore led to consider other molecule detection modes that are capable of discerning structure along the molecule at higher resolution and greater electronic sensitivity. Two possibilities are to sense molecules with a nanoscale field effect transistor (FET) embedded across the pore diameter or by observing tunneling or other forms of electronic transport between gapped electrodes embedded in the nanopore.^{6,10} Important steps to fabricating gapped metallic electrodes atop a nanopore have recently been demonstrated.^{11,12}

But instead of metallic probes, an electrically contacted carbon nanotube across the diameter of the nanopore is particularly attractive because of its chemical stability, nanoscale dimensions and highly ordered structure. Such a nanotube can serve as a FET^{13,14} or, when suitably gapped, as the probes of a tunneling device.^{6,15–17} During molecular transport through such a device, electronic rather than ionic currents can be sensed, potentially offering improved signal to noise and a more controlled environment for molecular transport. But producing a nanopore with an embedded single walled carbon nanotube across its diameter is a significant challenge that has not previously been confronted. Controlled positioning at specific device locations remains one of the most significant hurdles in the application of carbon nanotubes,^{18,19} and our goal was to devise a straightforward method that could easily, but reproducibly, produce many devices having an embedded single walled carbon nanotube across at least one nanopore of any chosen diameter. Here we demonstrate one way such devices can be realized.

II. EXPERIMENT

Figure 1 presents a schematic of the fabrication method. First, a row of $1\ \mu\text{m} \times 1\ \mu\text{m}$ iron (Fe) catalyst pads for CVD growth of carbon nanotubes were patterned on a low stress silicon nitride (SiN_x) membrane by electron beam lithography (EBL), electron beam evaporation, and metal lift-off. Then, rows of ~ 30 nm diameter pores were milled through the membrane, usually in 11×11 arrays in the proximity of each of the $1\ \mu\text{m} \times 1\ \mu\text{m}$ Fe pads with an FIB [Fig. 2(a)]. The pores in each array were spaced $100\ \text{nm} \times 100\ \text{nm}$ center-to-center, such that each array of 121 pores measured $\sim 1\ \mu\text{m} \times \sim 1\ \mu\text{m}$ edge-to-edge. Carbon nanotubes were then grown from the Fe pads by CVD.²⁰ Typically at least one of

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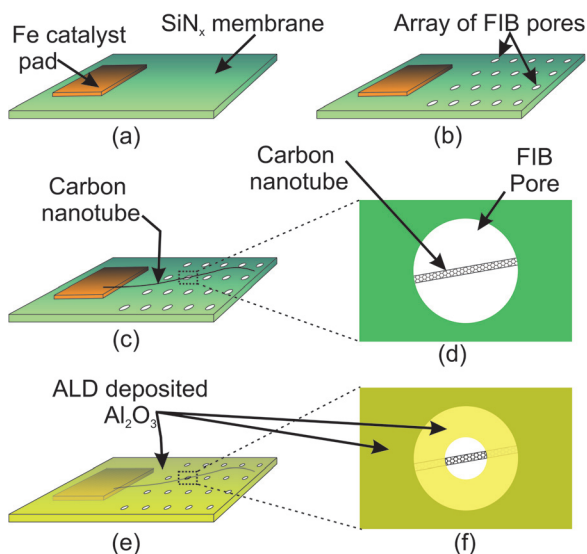


FIG. 1. (Color) Schematic diagram of the fabrication process of a carbon nanotube articulated nanopore. (a) Deposition of iron (Fe) pads on a silicon nitride membrane by a combination of electron beam lithography patterning and metal lift-off. (b) Arrays of nanopores are milled through the SiN_x membrane by a FIB machine. (c) Chemical vapor deposition growth of a carbon nanotube from the Fe pad over the array of pores. (d) Zoom-in view of a nanopore from the array with a carbon nanotube crossing its diameter. (e) A layer of aluminum oxide (Al_2O_3) is deposited by ALD. (f) Zoom-in view of the carbon nanotube articulated nanopore after ALD showing the decrease of its diameter by ALD growth of Al_2O_3 from the pores initial perimeter.

the carbon nanotubes growing from the Fe pad reached the pore array and crossed the center of at least one of the FIB pores. Because the Fe catalyst pad seeded the growth of multiple nanotubes that grew in many directions, we often noted several nanotubes that grew across other pores in the pore array.

To adjust the nanopore size and embed the nanotube in the finished nanopore, the samples were transferred to an ALD chamber that was used to conformally deposit multiple layers of insulating Al_2O_3 on all exposed surfaces, including the perimeter of the nanopores, but not on the portion of the nanotube that is to serve as an FET sensor or tunneling probe. ALD of high-dielectric materials has been shown to produce a benign dielectric/SWNT interface that does not adversely affect the electrical properties of the nanotube.^{21,22} Because ALD of Al_2O_3 is a self-limiting process that depends on half-cycle reactions that proceed through the formation of Al–O Lewis acid-base complexes,²³ the hydrophobic surface of a pristine defect-free carbon nanotube, in which all the carbon atoms are in sp^2 configuration, does not initiate the growth of aluminum oxide from its surface.^{22,24,25} Rather, the Al_2O_3 layers grew from all the silicon nitride surfaces, with lateral growth from the newly formed Al_2O_3 eventually burying only those portions of the carbon nanotube lying on the silicon nitride surface and near the inside diameter of the FIB pore. Deposition of a known number of Al_2O_3 layers, each of which is ~ 0.1 nm thick, on the inside diameter of the FIB pore shrank the pore diameter to a predictable smaller size,²⁶ with the length of exposed nanotube shrinking commensurately. Only the portion of the

suspended carbon nanotube that passed across the finished ALD coated nanopore remained uncoated (Fig. 3). Thus the Al_2O_3 coating could serve as a protective layer that insulates the nanotube from conducting fluid and the influence of proximal molecules anywhere in solution except in the finished nanopore.

We found the following procedural details consistently produced 2–10 nm nanopores whose diameters were crossed by one single-walled carbon nanotube. We started with $80 \times 80 \mu\text{m}$ free-standing, low-stress 250–270 nm thick SiN_x membranes, obtained by anisotropic KOH etching of a SiN_x coated silicon wafer.²⁷ To assure cleanliness, the silicon chips bearing the membranes were cleaned by dipping in trichloroethylene, acetone, and finally methanol, and baked at 150°C in air. Subsequently, a row of 0.5 to 1 nm thick $1 \mu\text{m} \times 1 \mu\text{m}$ Fe pads were patterned on the membrane using standard EBL processing (Raith-150 system) with a Poly(methyl methacrylate) (PMMA) resist that was lifted off with acetone followed by a rinse in isopropyl alcohol and drying in a N_2 atmosphere. The pore arrays were milled using a FEI Micrion 9500 FIB system operated at 50 kV acceleration voltage, with an aperture diameter of $15 \mu\text{m}$ corresponding to a 1.4 pA beam current. To obtain the smallest possible diameters of the pores, a single point (1 pixel) ion beam was rastered through the array ~ 100 times to obtain a total beam time of 6 s/pore. The resulting pores typically had ~ 35 –40 nm diameters and were spaced 100 nm apart in a square array. Each array, with typically 11×11 pores, was located $1 \mu\text{m}$ away from the premade Fe pads. Figure 2(a), shows a transmission electron microscope (TEM) image of an array of FIB milled pores (JEOL 2100 operated at 200 kV). In this example, the pores have a diameter of ~ 40 nm and it can be seen that the centered $11 \text{ pore} \times 11 \text{ pore}$ array is but one of several similar pore arrays which were patterned in a row parallel to the row of premade Fe catalyst pads (not shown). It is noted that the area of the membrane between the pores is partially milled because the ion beam was not blanked as it moved from one point to the next.

Carbon nanotubes were grown from the Fe pads in a 1 in. diameter quartz tube furnace (Lindberg/Blue Mini-Mite 1100°C), with methane gas (CH_4) as the carbon source. First, the sample temperature was ramped to 900°C in a flow of 500 sccm of Ar. When it reached 900°C , the sample was annealed in 200 sccm of pure H_2 for 10 min. Carbon nanotube growth was initiated by introducing a 1000 sccm flow of CH_4 for 15 min together with the 200 sccm H_2 flow. After growth, the system was cooled down to room temperature in a 500 sccm flow of Ar. These conditions usually yielded the growth of single-walled carbon nanotubes that were several microns in length with a high probability of at least one nanotube from each Fe catalyst pad growing across a nanopore array. Through many trials, we found the distances between the Fe-pads and the pore arrays and the spacing between the pores in each array stated above yielded a high probability that a nanotube would centrally cross the diameter of at least one pore [Fig. 2(b)].

Atomic layer deposition of Al_2O_3 was conducted in a home-built system at 225°C , by alternating cycles of flowing

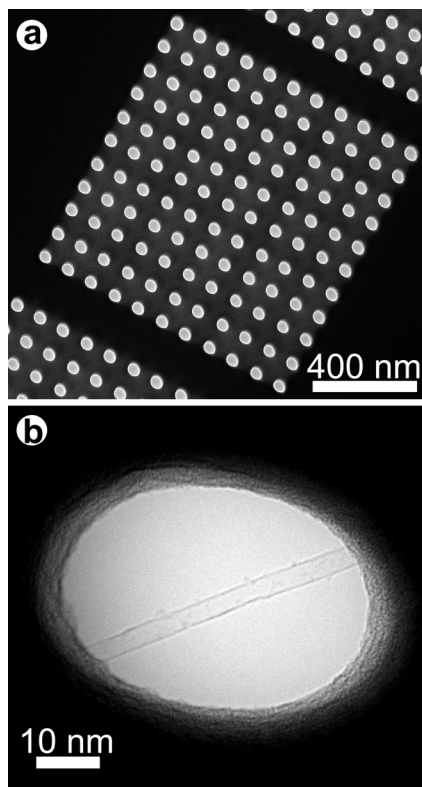


FIG. 2. Transmission electron microscopy images of (a) an FIB milled array of pores drilled through a SiN_x membrane. (b) A FIB milled pore from an array after a single-walled carbon nanotube has grown across the pore's diameter. Scale bar is 10 nm.

trimethylaluminum (TMA) vapor followed by water vapor. At the end of each cycle, one atomic layer of Al_2O_3 (thickness ~ 0.1 nm) was deposited.⁵ As shown in Fig. 3(b), the interface between the initial pore perimeter and the deposited Al_2O_3 layer can be seen in electron micrographs and it is clear that the carbon nanotube over the finished nanopore remained uncoated after the ALD had shrunk the pore to the finished desired diameter. In this example, the final nanopore diameter was 11 nm, the added alumina thickness was 10 nm, and the nanotube diameter was 2.6 nm, but by using fewer or more ALD cycles, the same procedure was used to produce many other larger or smaller diameter nanopores crossed by an embedded nanotube. To keep the nanotube across the finished nanopore free from alumina deposition, direct exposure to an electron beam during SEM or TEM observation [as was done to produce the image in Fig. 2(b)] must be avoided before the ALD processing. This is because direct exposure to an e -beam inevitably contaminates or causes defects in the nanotube which then nucleate alumina deposition.

With appropriate electrical connections to the carbon nanotube, the exposed length of a semiconducting nanotube that crosses the finished nanopore diameter [Fig. 3(b)] can serve as an FET single molecule detector because the translocation of a molecule in its immediate vicinity will influence the carrier concentrations in the nanotube. Alternatively, a gapped nanotube with ends abutting the perimeter of the finished nanopore can serve as a tunneling device to sense and characterize molecules as they pass through the nanopore. To achieve the latter

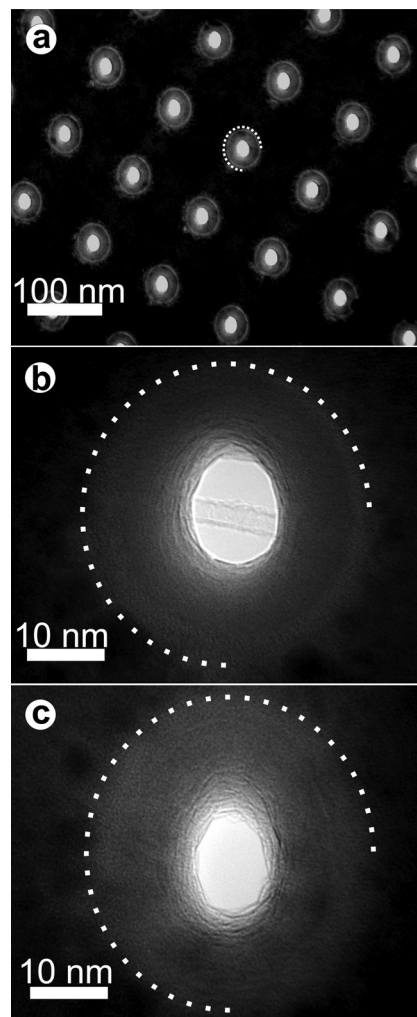


FIG. 3. Transmission electron microscopy images. (a) A nanopore array after the deposition of Al_2O_3 by ALD. The circular pattern of dots here and in (b) and (c) denotes the boundary of the initial FIB pore perimeter which encloses the subsequently deposited Al_2O_3 layers. (b) TEM image of a nanotube articulated nanopore after ALD deposition. (c) TEM image of the same nanopore as in (b), after the portion of the nanotube not covered with Al_2O_3 has been ablated with the microscope's electron beam.

configuration, the uncovered portion of the nanotube crossing the nanopore [Fig. 3(b)] can easily be eliminated by exposure to a low energy (e.g. 0.5–1 keV) sputter ion beam or plasma etch apparatus, which will rapidly remove the exposed length of the nanotube while leaving the alumina-covered portion of the original nanotube untouched. For illustrative purposes, even the electron beam of the TEM itself can be used, as can be seen in Fig. 3(c). But a low energy ion beam is preferred because its very short penetration distance into the alumina will minimize damage to the alumina covered portion of the gapped nanotube. Other methods of removing the suspended part of the nanotube over the nanopore, such as reactive ion etching, are currently being investigated.

III. DISCUSSION AND CONCLUSION

Using an ungapped or gapped carbon nanotube integrated with a nanopore will require electrically connecting the

appropriate positions of a selected nanotube to the outside world before they are buried and insulated by ALD. This can be accomplished without device damage or contamination by ice lithography²⁸ before the ALD procedure. As noted above, we have found that carbon nanotube exposure to an electron beam during standard EBL and lift-off damages or contaminates the nanotube. An unwanted consequence of such contamination or damage is that subsequent ALD coats the entire length of the nanotube,²⁵ including the portion that must remain uncoated if it is to serve as an FET or be gapped by an ion beam in the finished nanopore. Ice lithography avoids this problem because imaging, locating, and selecting the desired nanotube and determining the desired pattern of metal contacts are accomplished while the entire device, including the nanotube, is protected under a thin layer of water ice.²⁹ Furthermore, we and others have found that ALD of Al₂O₃ and other high-dielectric materials produces a benign dielectric/SWNT interface that does not adversely affect the electrical properties of the nanotube.^{22,30} Finally, we note that if the electrical signals from only the contacted nanotube that successfully crosses the diameter of a single nanopore is used to sense the presence of molecules translocating through that nanopore, the presence of unused nanopores in the pore array is of no concern.

In summary, we have demonstrated a simple and reproducible nanoscale fabrication technique for articulating a nanopore with a carbon nanotube. Although producing arrays containing a large number of such articulated nanopores cannot depend on individually selected e-beam lithographic processing and will require more elaborate, controlled methods to position nanotubes across the diameter of multiple nanopores, the simple approach we have demonstrated here is an important step towards the realization of a nanodevice platform whose value for in-solution sensing and characterization of molecules and biopolymers needs to be established before more elaborate, highly parallel and better controlled fabrication methods are implemented.

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